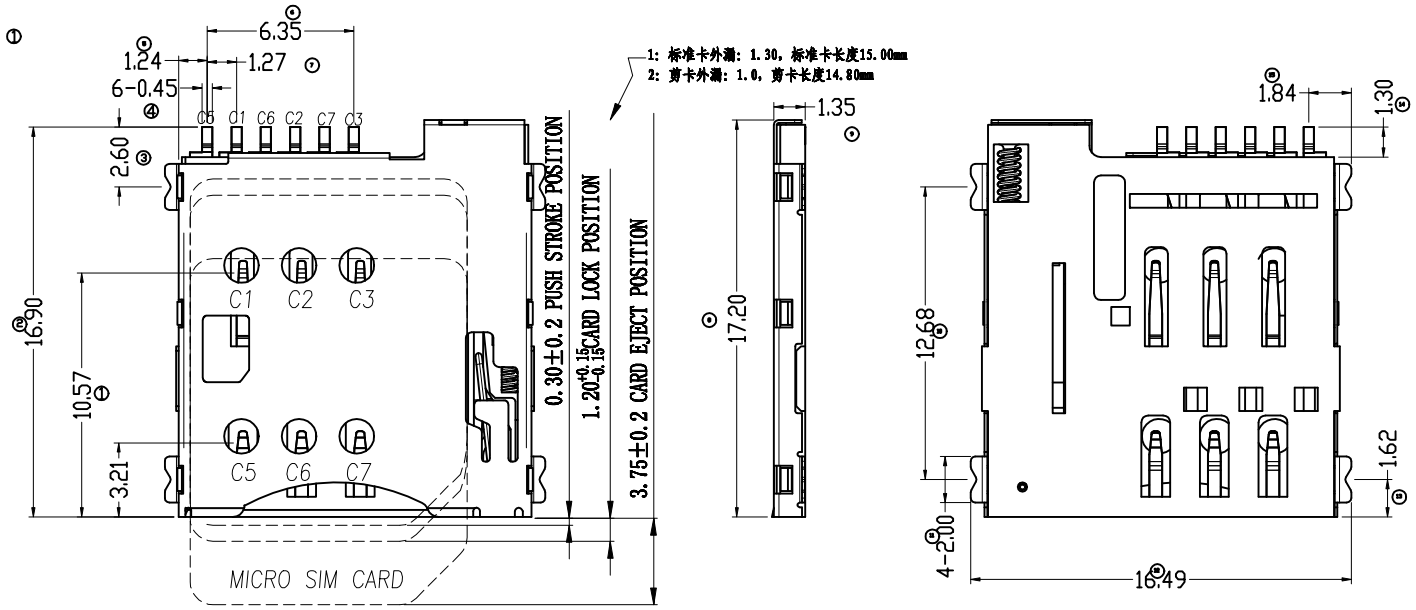
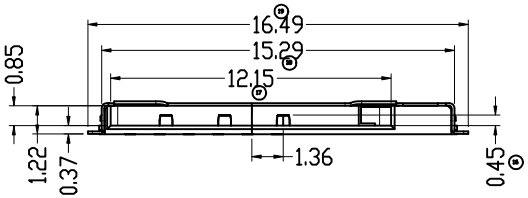
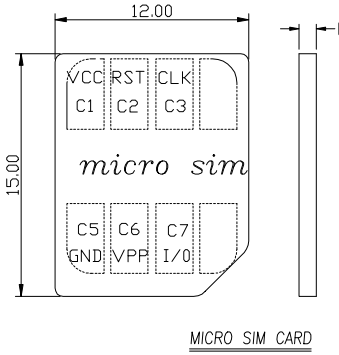
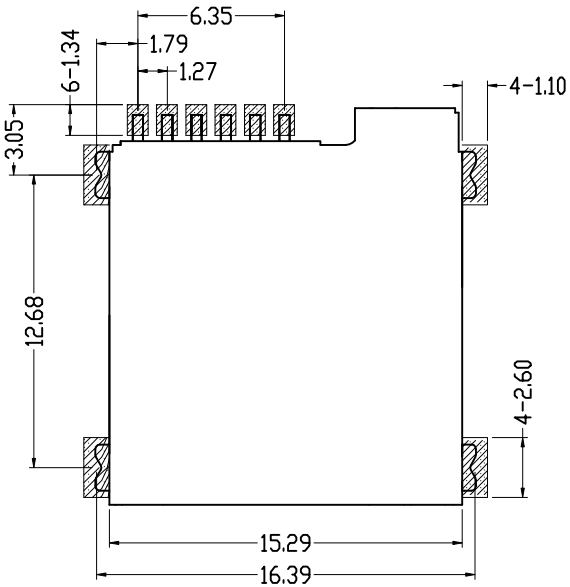
* 所有原料材质,生产制程,电镀必须符合ROHS要求







MICRO SIM CARD



PCB 焊盘区

下沉避位区

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u"Au Selective Contact Area

Electrical:

Current Rating :0.5mA AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m max. Ω
Insulation Resistance:1000M min./500VDC
产品耐温温度: 260° C $\frac{-C\ 5C1.7C)}{-5\ C}$ $\frac{C\ 5C1.7C)+5\ C}{C}$
Mating Cycles:3000Min Insertions

CRICUIT DIAGRAM FOR CARD DETECT SWITCH



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE

广东国连电子有限公司
GUANGDONG GUOLIAN ELECTRONICS CO.,LTD

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.15
X.XX: ±	0.10
X.XXX: ±	0.05
ANGULAR: ±	1°

PRODUCT NAME : MICRO-SIM 卡座PUSH/PUSH 1.35H 6P	DRAWING:	DATE:	
PRODUCT NO. : MIB5FW1062C1	CHECK:	DATE:	
DRAWING NO. :	APPROVED:	DATE:	
	SCALE: 1:1	DWG ID: C D	REV.: B
			PAGE: 1 OF 1